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### PATENT

Docket No. JCLA8482

Date: 12-19.

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# ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventors: Gwo-Ji Horng, Jen-I Kuo, Feng-Ger Hsiau

For: METHOD OF FABRICATING A CERAMIC SUBSTRATE WITH A THERMAL

CONDUCTIVE PLUG OF A MULTI-CHIP PACKAGE

Enc.	losed	are:	

Specification	_25_	pages.
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 $\bowtie$ 4 Sheets of drawings

Recordation Form Cover sheet with 2 pages assignment.

A certified copy of Taiwan Patent Application No. dated .

SIGNED declaration and power of attorney.

Return Prepaid postcard.

CLAIMS AS FILED										
FOR	NUMB	ER FII	ED 1	NUMBE	REXTRA	RATE	FEE			
Basic Fee						\$740.00	\$740.00			
Total Claims	49	_	20 =	29	×	\$18.00	\$522.00			
Independent Claims	7	_	3 =	4	×	\$84.00	\$336.00			
If application contains any multiple dependent claim (s), then add					\$280.00	\$0.00				
TOTAL FILING FEE				\$1,598.00						

A check in the amount of \$1598.00 cover the filing fee is enclosed.

A check in the amount of \$40.00 to cover the assignment recording fee.

A duplicate copy of this sheet is enclosed.

Jiawei Huang

Registration No. 43,330

## J.C. PATENTS, INC.

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Assistant Commissioner for Patents Washington, D.C. 20231

## **CERTIFICATE OF MAILING BY "EXPRESS MAIL"**

Docket No.

: JCLA8482

Applicant(s)

: Gwo-Ji Horng, Jen-I Kuo, Feng-Ger Hsiau

: METHOD OF FABRICATING A CERAMIC SUBSTRATE WITH A THERMAL CONDUCTIVE PLUG OF A MULTI-CHIP PACKAGE

"Express Mail"

: EV 016847757 US

Date of Deposit : December 19, 200/

I hereby certify that the accompanying

Transmittal in Duplicate; Specification <u>25</u> pages, <u>4</u> sheets of drawings; **SIGNED** Declaration and Power of Attorney <u>2</u> pages; Recordation Form Cover Sheet and Assignment <u>3</u> pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Michelle Chang